

ments. (2) Using the method outlined in our paper it is a simple matter to evaluate the expressions for the diamagnetic susceptibility of holes in germanium and silicon, using Wilson's³⁰ equation (6.8.1):

$$\chi = \frac{e^2}{12\pi\hbar^2c^2} \int \left[\frac{\partial^2\epsilon}{\partial k_x^2} \frac{\partial^2\epsilon}{\partial k_y^2} - \left(\frac{\partial^2\epsilon}{\partial k_x\partial k_y} \right)^2 \right] \frac{df_0}{\partial\epsilon} dV_k.$$

³⁰ See reference 6, p. 175.

If we apply the expansion scheme in spherical coordinates we obtain

$$\chi = -\frac{1}{6} \frac{e^2}{\hbar c^2} \left(\frac{KT}{2\pi m_0} \right) \exp[(\epsilon_v - \epsilon_F)/KT] (A \pm B)^{\frac{1}{2}} \{\gamma_\chi\},$$

where $\{\gamma_\chi\}$ is the γ series which appears above in the expression for σ_{ij} , Eq. (12).

Mechanical Strength of Thin Films of Metals*

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The tensile strength of silver films are determined as a function of their thickness. The films are electrodeposited on the complete cylindrical surfaces of small steel rotors and the rotor speeds necessary to throw them off are determined. Both the tensile strength and the adhesion of the films are obtained by using rotors of different radii. Also, the adhesion is measured by electrodepositing the films on the rotor in circumferentially disconnected patches which eliminate the hoop stresses. In most of the measurements, the adhesion is made vanishingly small by dipping the rotors in an albumin solution before electrodepositing the film and by thermal cycling. The tensile strengths of the films thicker than about 6×10^{-5} cm are found to be independent of thickness and approximately equal to that of bulk silver at the corresponding temperature. For thickness from 6×10^{-5} cm to 2.5×10^{-5} cm the data show some scatter, but below 2.5×10^{-5} cm the tensile strength increases many-fold. The region where the tensile strength increases very rapidly is slightly dependent upon the electrodeposition current but within experimental error is independent of film temperature.

UNDER the influence of tensile or shearing forces, a metal deforms elastically at first, and then plastically. Usually, plastic flow begins with stresses at least 100 times smaller than should be required to cause whole atomic planes in a perfect metal crystal to move over one another. This discrepancy between the calculated and observed values of the stresses required to produce plastic flow is generally attributed to the movement of lattice imperfections or dislocations which are believed to exist in most ordinary metal crystals.¹ This dislocation theory has been remarkably successful, not only in accounting for the low mechanical strength of metal crystals, but also for many other observed properties of substance that otherwise would be difficult to understand.² Consequently, if it were possible to free a metal crystal of its dislocations or to lock them so that they could not move, the stresses required to produce plastic flow would be increased enormously. Furthermore, in polycrystalline metals, where at temperatures well below their melting points fracture generally is observed to be transcrystalline,^{3,4} increased

strength should also be obtained. Apparently, the above conditions are at least partially realized experimentally, by forming the material in sufficiently fine filaments or thin sheets. Griffith⁵ found that under certain conditions the tensile strengths of very fine fibers of glass and of metals, were many times that of the bulk material from which they were made, while Orowan⁶ observed that extremely thin sheets of mica were very strong. More recently, Herring and Galt⁷ and others, have found that metal crystals (whiskers), approximately 18×10^{-5} cm in diameter, are several orders of magnitude stronger than the ordinary bulk metal. In some preliminary experiments⁸ an increase in the tensile strength of thin films of silver has been observed when their thickness was reduced to between 10^{-4} cm and 10^{-5} cm. The purpose of this paper is to report, in more detail, an extension and improvement of these measurements.

In order to prevent tearing or stress concentrations in the very thin films, a centrifugal field has been used to apply the stresses. The method consists in uniformly depositing thin metal films on the cylindrical surface of a small rotor with rounded ends and then spinning the rotor in a vacuum until the film is thrown off. By this procedure, accurately known stresses may be applied

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¹ A. H. Cottrell, *Progress in Metal Physics* (Interscience Publishers, New York, 1949), Vol. 1, p. 770.

² Seitz, Shockley, Read, and Mott in *Imperfections in Nearly Perfect Crystals* (John Wiley and Sons, Inc., New York, 1952).

³ R. King and B. Chalmers, *Progress in Metal Physics* (Interscience Publishers, New York, 1949), Vol. 1, p. 127.

⁴ C. S. Barrett, *Structure of Metals* (McGraw-Hill Book Company, Inc., New York, 1952), second edition.

⁵ A. A. Griffith, *Trans. Roy. Soc. (London)* **221**, 163 (1921).

⁶ E. Orowan, *Z. Physik* **82**, 235 (1933).

⁷ C. Herring and J. K. Galt, *Phys. Rev.* **85**, 1060 (1952).

⁸ Beams, Walker, and Morton, *Phys. Rev.* **87**, 524 (1952). Beams, Morton, and Turner, *Science* **118**, 567 (1953).

uniformly, and at almost any desired rate. By assuming that the centrifugal action is opposed by the hoop stresses, and the adhesion of the film to the rotor, it can be shown that in the case of a hollow thin-walled cylindrical rotor, unsupported at the ends,

$$4\pi^2 N^2 R^2 d = T + AR/h, \quad (1)$$

where N is the rotor speed in rps, R is the rotor radius, d the density of the deposited film, h the thin-film thickness, T the tensile strength of the film, and A the adhesion.

It will be observed that the second term on the right contains R/h , while the first does not, so that by experimenting with rotors of different radii, both the tensile strength and the adhesion can be obtained. On the other hand, if the ratio of the rotor radius to the film thickness is large, the second term on the right of Eq. (1) overshadows the first, and, unless the adhesion is small, minute variations in the adhesion make it difficult to get reliable values for the tensile strength. Although experiments are underway in which it is hoped that this ratio can be greatly reduced, in the present experiments this ratio is several hundred for the thinnest films. Consequently, the films have been deposited and treated in such a way that the adhesion is small.

If the adhesion of the film is vanishingly small, $4\pi^2 N^2 R^2 d = T$, which shows that the tensile strength is independent of the film thickness. This neglects the small effect of the circumferential strain or stretching of the film, and assumes that the film is thin and behaves plastically in a homogeneous way. On the other hand, if the hoop stress vanishes, as in the case when the material is deposited on the rotor surface in circumferentially disconnected patches, then the adhesion is given by $A = 4\pi^2 N^2 Rhd$.

DESCRIPTION OF EXPERIMENTAL ARRANGEMENT

The rotors are suspended magnetically in a vacuum and are spun around a vertical axis by a rotating magnetic field. The method is a modification of one previously described.⁹ Figure 1 shows a schematic diagram of a magnetic suspension apparatus for spinning rotors at various temperatures. The steel rotor is freely suspended inside of a glass vacuum chamber by the axially-symmetric diverging magnetic field of the solenoid. The vacuum chamber is surrounded by two concentric glass Dewar vessels, and the solenoid which is outside the outer Dewar vessel. They all have a common axis, as shown in Fig. 1. A small pickup coil, mounted inside the inner Dewar, and just below the vacuum chamber, serves as a sensing element of a servo-circuit, which regulates the current through the solenoid in such a way that the rotor is maintained at the desired vertical position. The rotor automatically seeks the strongest part of the field which is on the axis

of the solenoid. However, if disturbed, it swings around the axis. In order to prevent these horizontal oscillations, a steel damping needle (1 cm long and 0.1 cm diameter) is placed just below the sensing coil, and fastened to a weight in the inner Dewar with a fine gold chain 3.5 cm long. In order to spin the rotor at reduced temperatures, the two Dewars are filled with various liquids, i.e., when liquid nitrogen temperature is desired, they are filled with liquid nitrogen, etc. If the rotor starts to swing, the magnetic field follows it, and hence pulls the needle along with it. The viscous drag produced by the liquid on the damper is sufficient to stop the horizontal motion of the rotor. A cone-shaped plastic shield around the damper keeps bubbles formed near the bottom of the inner Dewar from disturbing the damper. The support solenoid consists of 21 110 turns of No. 23 AGW enamel copper wire wound on a plastic form. It has a resistance of 710 ohms, an inductance of 37 henries, and a disturbed capacity of 380 μf . The support circuit is shown in Fig. 2. The pick up coil L_1 is the inductive element in the grid circuit of a partially neutralized tuned-grid, tuned-plate oscillator which operates at about 6 Mc/sec. A change in the vertical

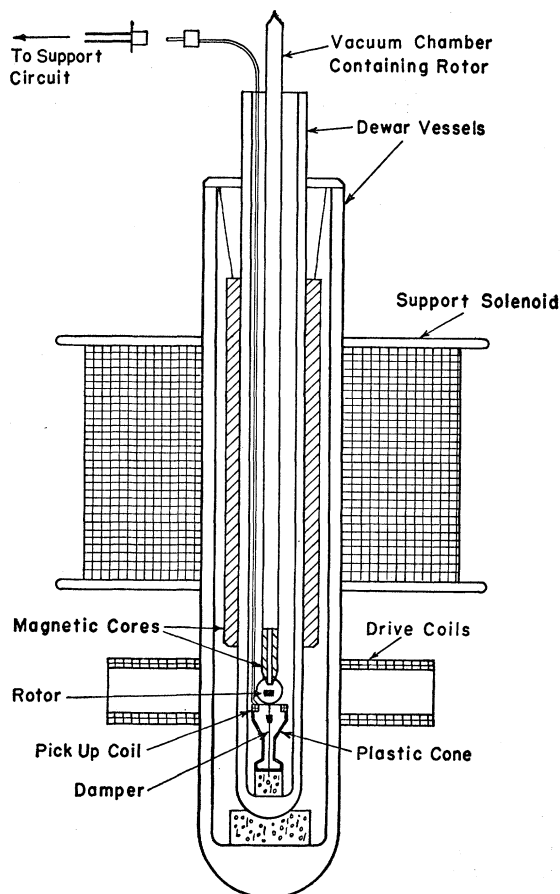


Fig. 1. Diagram of apparatus for spinning rotors at various temperatures.

⁹ Beams, Young, and Moore, J. Appl. Phys. 17, 886 (1946).

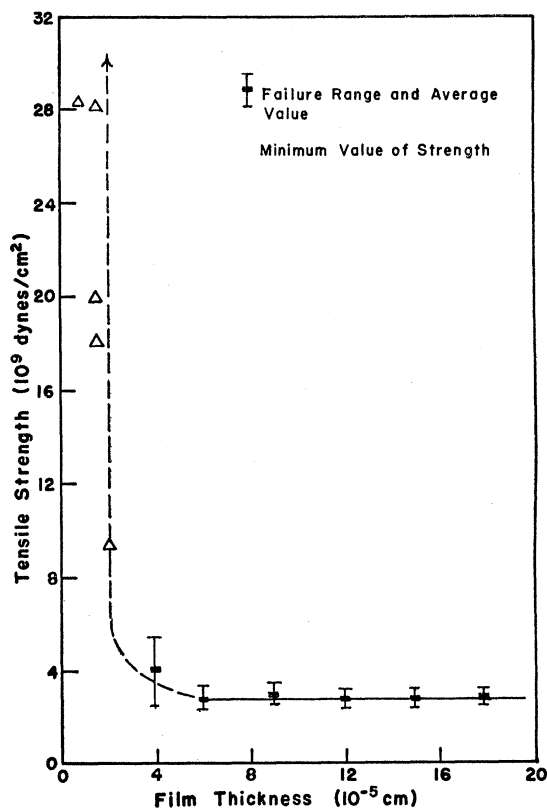


FIG. 3. Curve of tensile strength *versus* film thickness for silver at maximum temperature of 170°K.

the support circuit. Since this frequency is radiated, it may be picked up by a radio receiver in its vicinity. A highly selective RCA type CRV-46131 receiver has been used in this work. With the receiver beat-frequency oscillator in operation, the receiver is tuned to the support-circuit frequency and then detuned to give a low audio-frequency note in the loudspeaker. This note changes pitch abruptly when the film is thrown off the rotor. Also, such a system is useful in monitoring the support circuit.

The film thicknesses were measured by the usual weighing technique, and by light interference methods. In most of the experiments, curves of film thickness *versus* charge transferred in the electroplating process were made. The film thicknesses could then be determined from the amount of charge transferred, with an over-all precision of about one percent.

As pointed out above, the measurement of tensile strength is greatly simplified if the adhesion can be reduced to a negligible value. Consequently, silver films of different thicknesses were deposited on the rotors in patches, and the absolute value of the adhesion A determined by the relation $A = 4\pi^2 N^2 R h d$. By this procedure the technique of electroplating, described above, for effectively eliminating adhesion was developed and tested. At first sight, it may appear that the

patches might loosen around the edges, and that they would "rip off." However, close examination showed this not to be the case. Actually, because of the masking plastic, the deposited films were slightly thinner on the edges, which probably prevents ripping. Also, all of the patches on the rotor came off at approximately the same rotor speed. Incidentally, this method of measuring adhesion has turned out to be very reliable, and gives absolute values.

Figure 3 shows the values obtained for the tensile strength of silver as a function of film thickness. The temperature was above room temperature, the plating current 8.5 ma/cm 2 , and the rotor diameter 0.28 cm. It will be observed that for thicknesses greater than 6×10^{-5} cm the tensile strength is about 1.2×10^9 dynes/cm 2 , and is independent of the thickness. This is approximately equal to the bulk strength of the silver at the operating temperature. Data not plotted in the figure showed the tensile strength to be independent of film thickness up to at least 10^{-4} cm. For thicknesses between 6×10^{-5} cm and 2.7×10^{-5} cm the data are more erratic, but there is some indication of a small increase in tensile strength. However, for thicknesses less than 2.5×10^{-5} cm, there is a many-fold increase in tensile strength. In fact, the tensile strengths of the thin silver films are so great that the solid steel rotors explode before the films burst. The triangles in Fig. 3

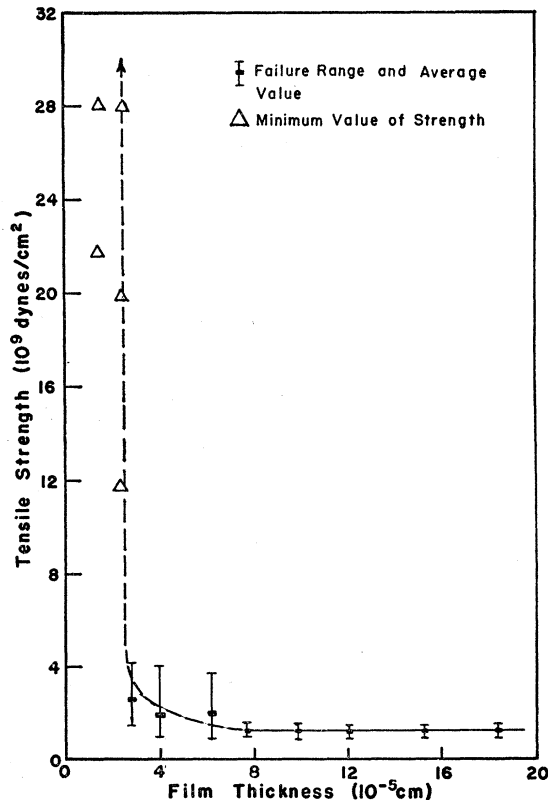


FIG. 4. Curve of tensile strength *versus* film thickness for silver at approximately 330°K.

and Fig. 4 represent points where the rotor speed was not sufficient to burst the film. In some of these cases the rotor was carefully brought to rest and a small cut made across the film in such a way as to eliminate the hoop stress. When the rotors were accelerated again, the films were observed to fly off completely at comparatively low rotor speeds, which was additional evidence that adhesion played no part in the observed tensile strength.

Figure 4 shows a typical plot of film thickness *versus* tensile strength for silver, when liquid nitrogen was introduced into the Dewar flasks surrounding the rotor chamber. The electroplating current was 8.5 ma/cm² and the rotor 0.28 cm in diameter. Here again it will be observed that the tensile strength is within experimental error, independent of the film thickness for thicknesses greater than about 6×10^{-5} cm. However, the strengths of these films are somewhat larger (about 2.9×10^9 dynes/cm²). It is believed that this is the bulk strength of the silver at the temperature of the rotor. Also, as in Fig. 3, the tensile strength increases many times for thicknesses less than 2.5×10^{-5} cm. Because of the rotor heating discussed above, produced by the eddy currents induced in the rotor by the acceleration, the exact temperatures of the rotors used in obtaining the data for both Fig. 3 and Fig. 4 can only be roughly estimated. However, the temperature of the rotor in Fig. 3 was probably around 330°K and that of Fig. 4 at least 160°K lower or a maximum of 170°K. In view of this, the data indicate that the thickness below which the tensile strength shows the very rapid increase is within experimental error, independent of temperature.

First it should be emphasized that the observed strength of the thick films (1.2×10^9 dynes/cm²) is of the order of 200 times the yield stress of 5.9×10^6 dynes/cm² ($3 \times 10^{-6} \mu$, where μ is the minimum shear modulus) of an annealed single crystal of silver.⁴ This may be due to the fact that every grain deforms and hardens by ordinary multiple slip. However, it is possible that the high strength results from the fact that only a fraction of the grains (the larger ones) contain Frank-Read sources^{11,12} of length smaller than

the grain size (say 10^{-4} or smaller). The piling up of dislocations produced by these sources at the grain boundaries, necessary to nucleate dislocations in the neighboring grains, would then provide the high strength. This interpretation implies, of course, a further increase of strength if the grain size is further decreased. If this interpretation is correct, then it is probable that when the films consist of a monolayer of grains, none of them should be able to stabilize Frank-Read sources in their interior,¹³ and therefore the films should quite suddenly increase their strength to the theoretical shear strength. In fact, if an orientation factor of the order of 2 is taken into consideration, the maximum shear strength observed with our thinner films approach within roughly an order of magnitude of the theoretical value.^{11,12}

If the greatly increased tensile strength at small film thicknesses is due to the absence of dislocations, the difficulty of generating new dislocations, etc., then one should observe no appreciable slip in the stretched films. However, it is difficult to decide this point, even by the electron microscope, because of the small thickness of the films, but we have in progress special experiments which should not only determine the slip, but also the Young's modulus in films formed both by electro-deposition and by evaporation. Recently, Mr. W. K. Ford and one of us, have found an increase in the tensile strength of evaporated films when the films are very thin, by measuring the bulge of the films through a support, produced by air pressure. However, the results so far, are preliminary, and much less precise than the data of Figs. 3 and 4.

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¹¹ F. C. Frank and W. T. Read, Jr., *Phys. Rev.* **79**, 722 (1950).

¹² A. H. Cottrell, *Dislocations and Plastic Flow in Crystals* (Oxford University Press, New York, 1953).

¹³ W. T. Read, Jr., *Dislocation in Crystals* (McGraw-Hill Book Company, Inc., New York, 1953).